

PS9924

Data Sheet

R08DS0059EJ0100 Rev.1.00 Jun 28, 2013

HIGH CMR, 10 Mbps OPEN COLLECTOR OUTPUT TYPE, 8-PIN LSDIP PHOTOCOUPLER FOR CREEPAGE DISTANCE OF 14.5 mm

DESCRIPTION

The PS9924 is an optical coupled high-speed, active low type isolator containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

FEATURES

- Long creepage distance (14.5 mm MIN.)
- High common mode transient immunity (CM_H, CM_L = ± 15 kV/ μ s MIN.)
- High-speed response ($t_{PHL} = 100 \text{ ns MAX.}$, $t_{PLH} = 100 \text{ ns MAX.}$)
- Low power consumption ($V_{CC} = 3.3/5V$)
- 8-pin LSDIP (Long Creepage SDIP) type
- Embossed tape product: PS9924-F3: 1 000 pcs/reel
- Pb-Free and Halogen Free product
- · Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - SEMKO approved (EN 60065, EN 60950)
 - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

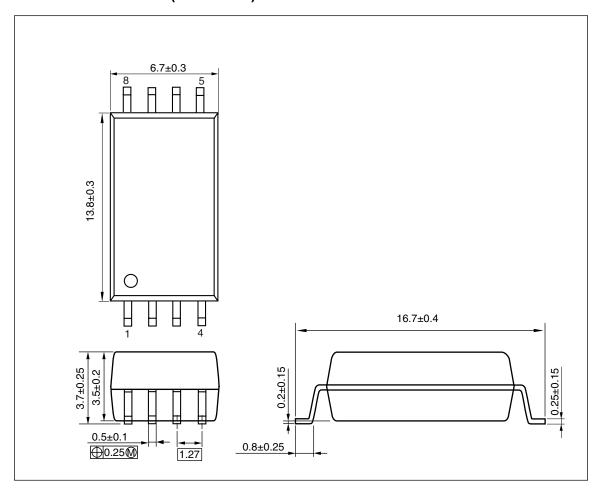
PIN CONNECTION (Top View) 8 7 6 5 1. NC 2. Anode 3. Cathode 4. NC 5. GND 6. Vo 7. NC 8. Vcc

APPLICATIONS

- Industrial inverter
- Solar inverter



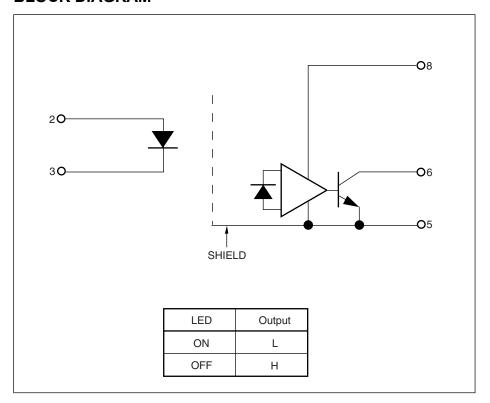
PACKAGE DIMENSIONS (UNIT: mm)



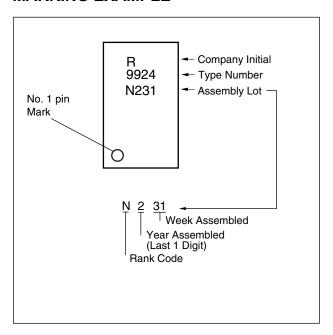
PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	14.5 mm
Creepage Distance	14.5 mm
Isolation Distance	0.4 mm

BLOCK DIAGRAM



MARKING EXAMPLE





ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS9924	PS9924-Y-AX	Pb-Free and	10 pcs (Tape 10 pcs cut)	Standard products	PS9924
PS9924-F3	PS9924-Y-F3-AX	Halogen Free	Embossed Tape 1 000	(UL, CSA, SEMKO	
		(Ni/Pd/Au)	pcs/reel	approved)	
PS9924-V	PS9924-Y-V-AX		10 pcs (Tape 10 pcs cut)	DIN EN 60747-5-5]
PS9924-V-F3	PS9924-Y-V-F3-AX		Embossed Tape 1 000	(VDE 0884-5)	
			pcs/reel	approved (Option)	

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	I _F	25	mA
	Reverse Voltage	V_R	5	V
	Power Dissipation*1	P _D	45	mW
Detector	Supply Voltage	V _{CC}	7	V
	Output Voltage	Vo	7	V
	Output Current	Io	25	mA
	Power Dissipation *2	Pc	250	mW
Isolation Voltage *3		BV	7 500	Vr.m.s.
Operating A	Ambient Temperature	T _A	-40 to +110	°C
Storage Te	mperature	T _{stg}	−55 to +125	°C

Notes: *1. Reduced to 0.8 mW/ $^{\circ}$ C at T_A = 85 $^{\circ}$ C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Low Level Forward Voltage	$V_{F(OFF)}$	-2		0.8	V
High Level Forward Current	I _{F(ON)}	8	10	12	mA
Supply Voltage	V _{CC}	2.7		5.5	V
Pull-up Resistor	R_L	330		4k	Ω

^{*2.} Reduced to 5.2 mW/°C at T_A = 85°C or more.

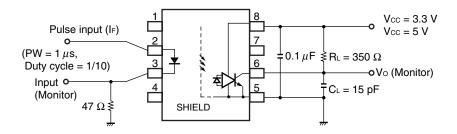
^{*3} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.



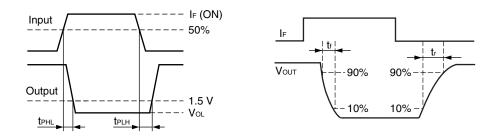
<R> ELECTRICAL CHARACTERISTICS ($T_A = -40$ to +110°C, unless otherwise specified)

	Parameter	Symbol	Conditions		MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V_{F}	$I_F = 10 \text{ mA}, T_A = 25^{\circ}\text{C}$ $V_R = 3 \text{ V}, T_A = 25^{\circ}\text{C}$ $f = 1 \text{ MHz}, V_F = 0 \text{ V}, T_A = 25^{\circ}\text{C}$		1.3	1.56	1.8	V
	Reverse Current	I _R					10	μΑ
	Terminal Capacitance	Ct				30		pF
Detector	High Level Output Current	I _{OH}	$V_{CC} = V_{O} = 3.3 \text{ V}$	V_{r} , V_{r} = 0.8 V_{r}		1	80	μΑ
			$V_{CC} = V_{O} = 5.5 \text{ V}$		1	100		
	Low Level Output Voltage	V_{OL}	$V_{CC} = 3.3 \text{ V}, I_F =$	$V_{CC} = 3.3 \text{ V}, I_F = 10 \text{ mA},$			0.6	V
			I _{OL} = 13 mA	I _{OL} = 13 mA				
			$V_{CC} = 5.5 \text{ V}, I_F =$	10 mA,				
			I_{OL} = 13 mA					
	High Level Supply Current	I _{CCH}	$V_{CC} = 3.3 \text{ V}, I_F =$	0 mA,		2	7	mA
			V _O = open					1
			$V_{CC} = 5.5 \text{ V}, I_F =$	0 mA,		3	7	
			V _O = open					
	Low Level Supply Current	I_{CCL}	$V_{CC} = 3.3 \text{ V}, I_F =$	10 mA,		4	10	mA
			V _O = open			_		4
			$V_{CC} = 5.5 \text{ V}, I_F =$		5	10		
0 1 1	The section of the se		V _O = open	050.0				
Coupled	Threshold Input Voltage	I _{FHL}		$V_{CC} = 3.3 \text{ V}, R_L = 350 \Omega,$		2	5	mA
	$(H \rightarrow L)$		V _O = 0.8 V	250.0				
			$V_{CC} = 5.0 \text{ V}, R_L = 0.0 \text{ V}$	= 350 \O_{\text{,}}				
	Isolation Resistance	D	$V_0 = 0.8 \text{ V}$ $V_{I-O} = 1 \text{ kV}_{DC}, \text{ RH}$	10 ¹¹			Ω	
	Isolation Capacitance	R _{I-O}	$V_{I-O} = 1 \text{ KV}_{DC}, \text{ RP}$ $V_{I-O} = 0 \text{ V}, \text{ f} = 1 \text{ N}$		10	1.0		1
	Isolation Capacitance	C_{I-O}	$T_A = 25^{\circ}C$		1.0		pF	
	Propagation Delay Time	t _{PHL}		T _A = 25°C		45	75	ns
				1A - 23 C		40	73	113
	(11 → L)		$I_F = 10 \text{ mA},$ $R_L = 350 \Omega,$	T _A = -40°C to			100	
			C _L = 15 pF	110°C			100	
				T _A = 25°C		45	75	1
			$I_F = 10 \text{ mA},$	1A - 23 C		40	73	
				T _A = -40°C to			100	
			C _L = 15 pF	110°C			100	
	Propagation Delay Time $(L \rightarrow H)^{*2}$	t _{PLH}		T _A = 25°C		40	75	ns
			$I_{\rm F} = 10 \text{ mA},$	1 _A – 25 C		70	7.5	113
	(L -> 11)		I	T - 4000 to			100	1
			C _L = 15 pF	$T_A = -40^{\circ}C$ to 110°C			100	
				T _A = 25°C		40	75	1
			$I_{\rm F} = 10 \text{ mA},$	1 _A – 25 C		70	7.5	
				T _A = -40°C to			100	1
			C _L = 15 pF	110°C			100	
	Pulse Width Distortion	t _{PHL-} t _{PLH}	· · · · · · · · · · · · · · · · · · ·			5	35	ns
	(PWD)*2	IPHL-IPLH	V_{CC} = 3.3/5 V, I_F = 10 mA, R_L = 350 Ω , C_L = 15 pF			3	33	113
	Propagation Delay	t _{psk}		- ~ P.			40	1
	Skew*2	-port						
	Rise Time*2	t _r	1			20		1
	Fall Time*2	t _f]			5		1
	Common Mode	CM _H	$V_{CC} = 3.3/5 \text{ V}, I_F = 0 \text{ mA}, V_O > 2 \text{ V}, R_L = 350 \Omega,$		15	20		kV/μs
	Transient Immunity at	- 11			=			
	High Level Output*3		$V_{CM} = 1 \text{ kV}, T_A =$					
	Common Mode	CML	$V_{CC} = 3.3/5 \text{ V}, I_{F}$	15	20		kV/μs	
	Transient Immunity at		$V_0 < 0.8 \text{ V}, R_L =$					
	Low Level Output*3		$V_{CM} = 1 \text{ kV}, T_A =$					

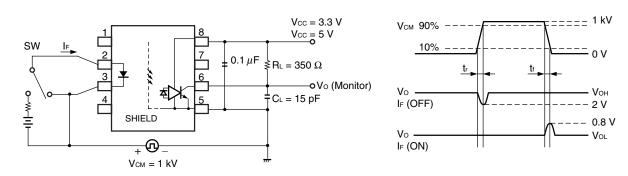
- Notes: *1. Typical values at $T_A = 25^{\circ}C$
 - *2. Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

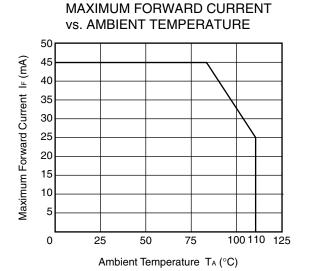


*3. Test circuit for common mode transient immunity

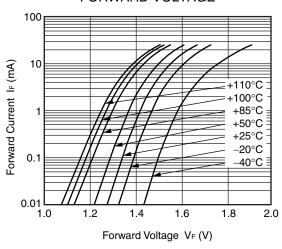


Remark C_L includes probe and stray wiring capacitance.

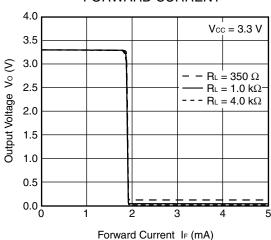
<R> TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)



FORWARD CURRENT vs. FORWARD VOLTAGE

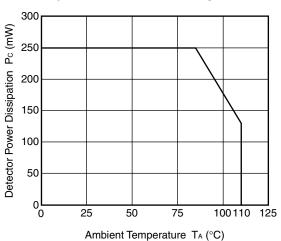


OUTPUT VOLTAGE vs. FORWARD CURRENT

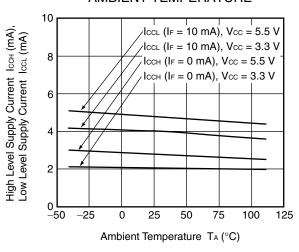


Remark The graphs indicate nominal characteristics.

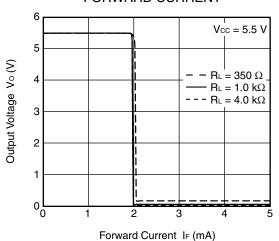
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



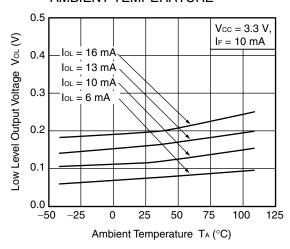
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



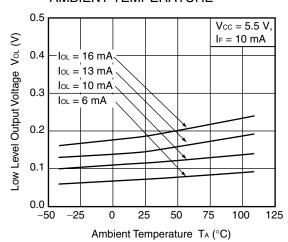
OUTPUT VOLTAGE vs. FORWARD CURRENT



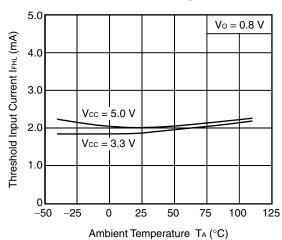
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



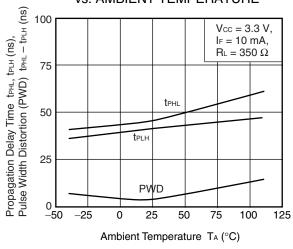
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

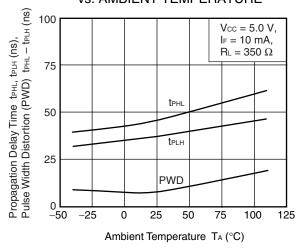


PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

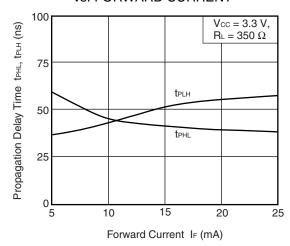


Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

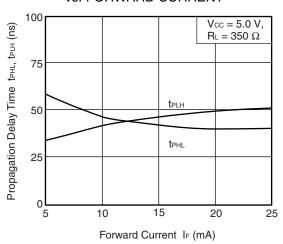


PROPAGATION DELAY TIME vs. FORWARD CURRENT

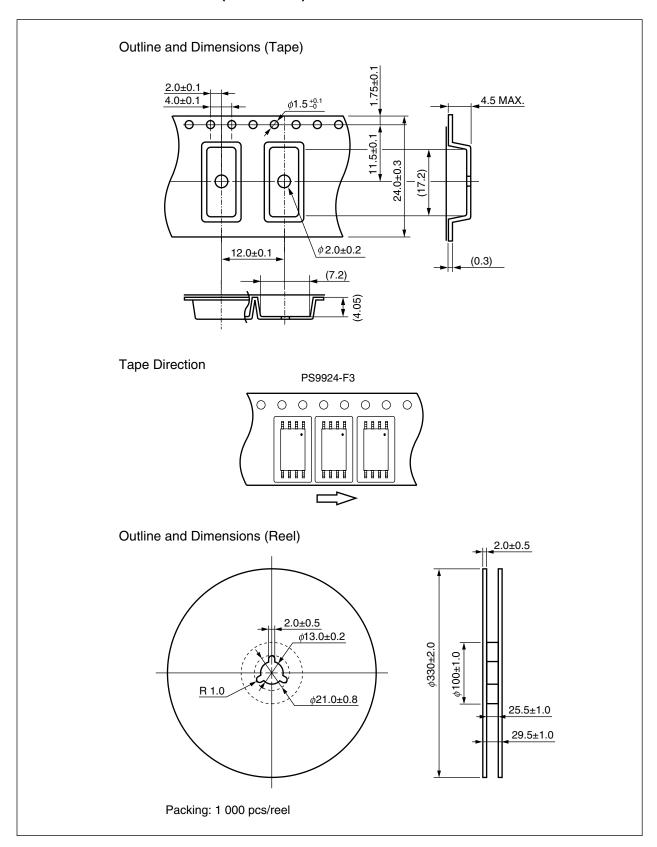


Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME vs. FORWARD CURRENT

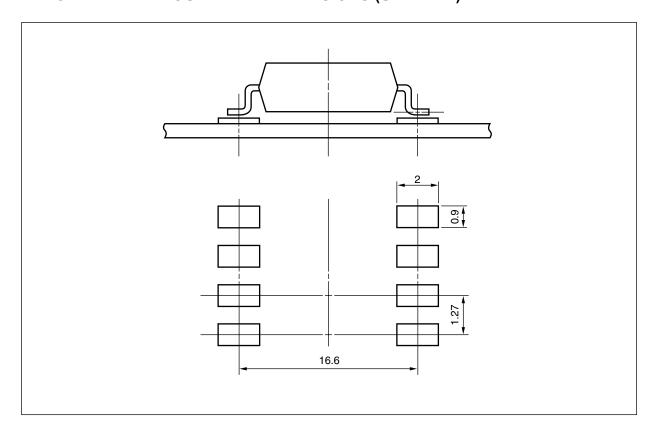


TAPING SPECIFICATIONS (UNIT: mm)





RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

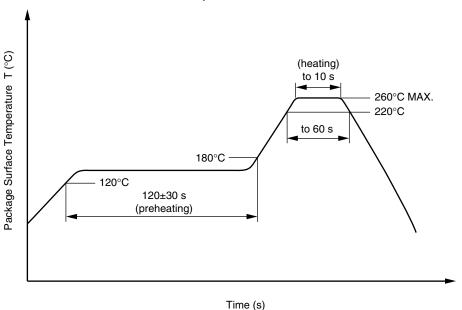
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

Time to preheat temperature from 120 to 180°C
 Number of reflows
 Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2

Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)
 Time (each pins)
 350°C or below
 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead



(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than $0.1 \,\mu\text{F}$ is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Pin 1, 4 (which is an NC*1 pin) can either be connected directly to the GND pin on the LED side or left open. Also, Pin 7 (which is an NC*1 pin) can either be connected directly to the GND pin on the detector side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.
 - Note: *1. NC: Non-Connection (No Connection).
- 4. Avoid storage at a high temperature and high humidity.

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

Revision History

PS9924 Data Sheet

		Description			
Rev.	Date	Page	Summary		
0.01	Apr 06, 2012	_	First edition issued		
1.00	Jun 28, 2013	p.5	Modification of ELECTRICAL CHARACTERISTICS		
		pp.7 to 9	Addition of TYPICAL CHARACTERISTICS		

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